

Product Information

Electronic Protection System

Urethane/Alkyd Thin Film Coating

Bectron[®] PL 4122-E BLF

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Product description

Bectron® PL 4122 E BLF FLZ is a range of transparent coating polyurethane varnishes based on established urethane modified alkyd chemistry. The performance of Bectron® PL 4122 E BLF FLZ meets the latest requirements of electronics, low pin corrosion and fast curing at room temperature or oven cure conditions.

Bectron® PL 4122 E BLF FLZ is lead-free and has no aromatic compounds in the solvent and satisfies the requirements of the ROHS directive.

The varnish features superior performance in thermal and dielectric properties which are maintained when subjected to environmental stress.

The coating varnish is available in the following grades:

- 3 solids/viscosity levels for each application system:

PL 4122-37 E BLF FLZ
PL 4122-40 E BLF FLZ
PL 4122-45 E BLF FLZ

- Orange colour option if preferred.

PL 4122-37 E BLF OR
PL 4122-40 E BLF OR
PL 4122-45 E BLF OR

Application

Coating of electronics:

- PCB's subject aggressive environment
 - automotive or marine navigation
 - Industrial
 - Corrosive gas
- hybrids
- SMD devices
- discrete components
- Suitable for safety critical systems

Main Properties of Bectron PL 4122E BLF

- High temperature index of 134°C
- Listed in UL 94 V0
- Superior Dielectric properties
- High volume resistivity including humid conditions
- Resists moisture, water, corrosive gas, chemicals
- Excellent adhesion to most surfaces
- All performance properties in very thin films
- ROHS Compliant
- Inspection of coated area is possible under UV light

Resistance to Harsh Conditions

Components varnished with Bectron® PL 4122 E BLF provide maximum protection against contaminants such as moisture and dust and many chemicals. It is resistant to corrosive gas atmosphere, weak acid fuels, oils, glycols and many other fluids used in automotive and shipping industry.

Bectron® PL 4122 E BLF can survive temperature shock and temperature cycling resistance such as -40 to +130°C for several cycles

The cured coating retains good adhesion but remains flexible to withstand distortion of the PCB (Mandrel bend test)

Processing

The coating varnish Bectron® PL 4122 E BLF is optimised for mass production robotic application on all major equipment systems including select coat, select spray nozzles and automated dipping systems. It can also be used with manual and simpler applications equipment by dipping, brushing or hand-spray. The Grades PL 4122-37 E BLF or 40E BLF are for general applications. For dipping PL 4122-45 E BLF is usually recommended with Thinner Bectron® 239 for dilution to the required viscosity. Bectron® PL 4122 E BLF is flammable and good ventilation is important in all processing areas.

Curing

For batch Curing:

- Air curing at 23°C for 16h
- Accelerated curing 80°C/0,5h

Continuous Oven Curing:

Very short cure times of about 10 minutes can be achieved with the correct temperature profile in a well regulated in-line oven. Caution is needed to limit the rate of temperature increase to avoid bubbles in the coating. Guidance on curing profiles is available on request.

Re-work

If a component needs to be replaced in the assembled printed circuits it is possible to solder through the cured coating and the coating needs to be replaced on the new solder joint. Cleaning Agent AC 93 can be used to remove the PL 4122 up to 24 hours after curing and cleaning of equipment.

Table 1: Typical properties of coating varnish

Property	Conditions	Value	Units
Non volatile content, ISO 3251 (Solids Content)	1,5 g, 2 h, 130°C		
Bectron PL 4122-37 E BLF		37 ± 1	%
Bectron PL 4122-40 E BLF		40 ± 1	%
Bectron PL 4122-45 E BLF		45 ± 1	%
Viscosity - Flow Time -, DIN/EN/ISO 2431 cup			
Bectron PL 4122-37 E BLF	4 mm-Cup, 23 °C	40 ± 3 (≈ 50)	Seconds (mPas)
Bectron PL 4122-40 E BLF	4 mm-Cup, 23 °C	65 ± 5 (≈ 80)	Seconds (mPas)
Bectron PL 4122-45 E BLF	6 mm-Cup, 23 °C	40 ± 3 (≈ 240)	Seconds (mPas)
Density, DIN 51757	23°C		
Bectron PL 4122-37 E BLF		0,86 ± 0,01	g/cm ³
Bectron PL 4122-40 E BLF		0,87 ± 0,01	g/cm ³
Bectron PL 4122-45 E BLF		0,88 ± 0,01	g/cm ³
Minimum shelf life	23 °C	6	months
Curing Time	23 °C, dust dry	0,25	h
	23 °C, touch dry	1,00	h
	23 °C, cured	16,00	h
	80°C (batch oven)	0.5	h

Table 2 – Thermal Properties of cured coating

Property	Condition	Value	Units
Temperature Resistance, IEC 60216		134	°C
Flammability File-No. E 211569	Vertical	UL 94 V0	

Table 3 - Mechanical properties of cured coating

Property	Condition	Value	Units
Mandrel Bend Test, IEC 60464-2	3 mm, 0.06 mm film	>180	°
Cross Cut Test, DIN 53151		GT 0 - 1	

Table 4 – Dielectric properties of cured coating

Property	Condition	Value	Units
Permittivity, IEC 60250	23°C 10 KHz	3.5	
Dielectric Dissipation Factor, IEC 60250	23°C 10 KHz	0.023	
Dielectric Strength, IEC 60464 part 2 - After 23 hours water immersion	23°C	112	KV/mm
		108	KV/mm
Volume Resistivity, IEC 60464 part 2	23°C	1 x 10 ¹⁵	Ω • cm
Tracking resistance, IEC 60112		600	CTI

Table 5 - Chemical properties of cured coating

Property	Condition	Value	Units
Water absorption, ISO 62	23°, 24 hours	1.5	%
	100°C, 0.5 hour	2.5	%

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